

1 1. A method comprising:
2 coupling a first and second surface of an
3 electronic device; and
4 injecting an encapsulant between said first and
5 second surfaces through one of said surfaces.

1 2. The method of claim 1 wherein injecting an
2 encapsulant includes forming a hole through one of said
3 surfaces and injecting encapsulant through said hole.

1 3. The method of claim 2 including forming a
2 centrally located hole and forming a plurality of radially
3 displaced holes arranged at a substantially uniform radius
4 from said centrally located hole.

1 4. The method of claim 3 including injecting
2 encapsulant through said centrally located hole until the
3 encapsulant reaches said radially displaced holes and
4 thereafter stopping the injection of encapsulant through
5 said centrally located hole and injecting encapsulant
6 through said radially displaced holes.

1 5. The method of claim 1 wherein injecting an
2 encapsulant includes causing an encapsulant front to extend
3 outwardly from the center of a region to be encapsulated
4 between said first and second surfaces.

1 6. The method of claim 5 including injecting
2 encapsulant through a central hole through one of said
3 surfaces.

1 7. The method of claim 6 including terminating the
2 injection of encapsulant through said central hole and
3 injecting encapsulant through a plurality of holes
4 substantially uniformly radially displaced with respect to
5 said central hole.

1 8. The method of claim 7 including stopping the
2 injection of said encapsulant through radially displaced
3 holes and initiating the injection of encapsulant through a
4 second set of holes radially displaced with respect to said
5 radially displaced holes.

1 9. The method of claim 1 including forming an
2 electronic display.

1 10. The method of claim 1 including injecting
2 encapsulant into the region between a pair of spaced
3 plates.

1 11. An electronic device comprising:
2 a first surface;

3 a second surface spaced from said first surface,
4 said second surface including at least one encapsulation
5 injection port extending through said surface; and
6 encapsulation between said first and second
7 surfaces.

1 12. The device of claim 11 wherein said device is a
2 display.

1 13. The device of claim 11 wherein one of said
2 surfaces is a glass panel.

1 14. The device of claim 11 wherein said surfaces are
2 surface mounted to one another.

1 15. The device of claim 11 wherein said device is an
2 organic light emitting display device.

1 16. The device of claim 11 including a plurality of
2 encapsulation injection ports extending through said first
3 surface.

1 17. The device of claim 16 including a centrally
2 located injection port, and a first array of substantially
3 uniformly radially displaced injection ports positioned

4 radially outwardly of said centrally located injection
5 port.

1 18. The device of claim 17 including a second array
2 of substantially uniformly displaced injection ports
3 positioned radially outwardly with respect to said first
4 array.

1 19. A method comprising:
2 injecting encapsulant into an electronic device
3 at a first location; and
4 when the encapsulant reaches a second location
5 spaced from said first location, injecting encapsulant at a
6 location proximate to said second location.

1 20. The method of claim 19 including coupling a first
2 and second surface of an electronic device and injecting
3 encapsulant between said first and second surfaces.

1 21. The method of claim 20 including forming a
2 centrally located hole and forming a plurality of radially
3 displaced holes arranged at a substantially uniform radius
4 from said centrally located hole.

1 22. The method of claim 21 including injecting
2 encapsulant through said centrally located hole until the
3 encapsulant reaches said radially displaced holes and
4 thereafter stopping the injection of encapsulant through
5 said centrally located hole and injecting encapsulant
6 through said radially displaced holes.

1 23. The method of claim 19 including forming an
2 electronic display.

1 24. The method of claim 19 including injecting
2 encapsulant into a region between a pair of spaced plates.

1 25. The method of claim 24 including injecting
2 encapsulant through one of said plates.